

Bently Nevada 3500 Series Service Manual

3500/61-01-00

1. Description

Manufacturer : Bently Nevada

3. Product Information

Manufacturer : Bently Nevada

Product No. : 3500/61-01-00

Product type : Temperature Monitors with Recorder Outputs

Made in U.S.A

I/O Module Type : 01 = RTD/TC Non-isolated I/O Module Internal Terminations

Agency Approval Option : 00 = None

Specifications

Inputs

Signal Accepts from 1 to 6 RTD or TC

transducer signals.

Input

Impedance

10 MΩ for each lead input.

Power Consumption

3500/60 Nominal consumption of 7

watts.

3500/61 Nominal consumption of 9

watts.

Transducers

TCs

Type E -100 °C to +1000 °C, (-148 °F to +1832 °F).

When using any of the isolated

thermocouple I/O modules (-03 or -04

I/O ordering option) with Type E

thermocouples, the available full-scale

range will be reduced if the 3500

system is operated in an ambient

temperature above +35C. The reduced

range will be -60C to +1000C (-76F to

+1832F). Rack configuration software

will allow the user to configure a

channel down to -100C but the system

will not function properly in this

scenario and therefore should not be

configured to operate with these

settings.

Type J -18 °C to +760 °C, (+0 °F to +1400 °F).

Type K -18 °C to +1370 °C, (+0 °F to +2498 °F)

.Type T -160 °C to +400 °C, (-256 °F to +752 °F).

RTDs

100Ω 3-wire

& 4-wire

platinum

RTD (alpha

= 0.00385)

-200° C to +850° C

(-328 °F to +1562 °F).

With external barriers:

-50 °C to +850 °C

(-122 °F to +1562 °F).

100Ω 3-wire

& 4-wire

platinum

RTD (alpha

= 0.00392)

-200 °C to +700 °C
(-328 °F to +1292 °F).

With external barriers:

-50 °C to +260 °C
(-122 °F to + 1292 °F).

120Ω 3-wire

& 4-wire

nickel RTD

-80 °C to +260 °C
(-112 °F to +500 °F).

With external barriers:

-50 °C to +260 °C
(-122 °F to + 500 °F).

10Ω 3-wire &

4-wire

copper RTD

-100 °C to +260 °C,
(-148 °F to +500 °F).

With external barriers:

-50 °C to +260 °C
(-122 °F to +500 °F).

Platinum RTD's with
0.00385 alphas are the
worldwide industrial
standard and are
recommended for all
applications

I/O Modules

Isolated I/O Module

System Isolation: 500Vdc

Channel to Channel Isolation:

250 Vdc

Isolation is only required for
fault scenarios and these
voltages will not be present on
the I/O module inputs when a
wiring or field fault occurs.

Outputs

Front Panel LEDs

OK LED Indicates when the
Temperature Monitor is
operating properly.

TX/RX LED Indicates when the Temperature
Monitor is communicating with
other modules in the 3500 rack.

Bypass LED Indicates when the
Temperature Monitor is in
Bypass Mode.

RTD Current Source Value

925 ±15 µA @ 25° C per transducer (single
supply for the 4-wire RTD and two supplies for
the 3-wire).

Recorder

+4 to +20 mA. Values are proportional to
monitor full-scale. Individual recorder values
are provided for each channel. Monitor
operation is unaffected by short circuits on
recorder outputs.

Voltage Compliance (current output)

0 to +12 Vdc range across load. Load

resistance is 0 to 600 Ω .

Resolution

0.3662 μ A per bit $\pm$ 0.15% error at room

temperature $\pm$ 0.4% error over temperature
range.

Signal Conditioning

Specified at +25 $^{\circ}$ C (+77 $^{\circ}$ F) unless
otherwise noted.

Full-scale range for each

channel is set in the field via

3500 Configuration Software. No

calibration is required.

RTDs and TCs (except for 10 Ω Copper RTDs)

Resolution 1 $^{\circ}$ C or 1 $^{\circ}$ F

Accuracy

Internal

Termination

NonIsolated

Bulkhead

Rack

$\pm$ 3 $^{\circ}$ C at 25 $^{\circ}$ C

($\pm$ 5.4 $^{\circ}$ F at 77 $^{\circ}$ F).

Standard

Rack

$\pm$ 3 $^{\circ}$ C at 25 $^{\circ}$ C

($\pm$ 5.4 $^{\circ}$ F at 77 $^{\circ}$ F).

External Termination Non-Isolated

Bulkhead

Rack

$\pm$ 3 $^{\circ}$ C at 25 $^{\circ}$ C

($\pm$ 5.4 $^{\circ}$ F at 77 $^{\circ}$ F).

Standard

Rack

$\pm$ 1 $^{\circ}$ C at 25 $^{\circ}$ C

($\pm$ 1.8 $^{\circ}$ F at 77 $^{\circ}$ F).

Internal Termination Isolated

Bulkhead

Rack

$\pm$ 2 $^{\circ}$ C at 25 $^{\circ}$ C

($\pm$ 3.6 $^{\circ}$ F at 77 $^{\circ}$ F).

$\pm$ 3 $^{\circ}$ C at 25 $^{\circ}$ C

$\pm$ 5.4 $^{\circ}$ F at 77 $^{\circ}$ F).

Standard

Rack

$\pm$ 3 $^{\circ}$ C at 25 $^{\circ}$ C

$\pm$ 5.4 $^{\circ}$ F at 77 $^{\circ}$ F).

External Termination Isolated

Bulkhead

Rack

$\pm$ 1 $^{\circ}$ C at 25 $^{\circ}$ C

($\pm$ 1.8 $^{\circ}$ F at 77 $^{\circ}$ F).

Standard

Rack

$^{\circ}$ C at 25 $^{\circ}$ C

($\pm$ 1.8 $^{\circ}$ F at 77 $^{\circ}$ F)

10 Ω Copper RTDs

Resolution 1 $^{\circ}$ C or 1 $^{\circ}$ F

Accuracy $\pm$ 3 $^{\circ}$ C at 25 $^{\circ}$ C

(±5.4 °F at 77 °F).

Cold Junction Compensation Sensor (used for TC measurements)

Accuracy ±1° C at 25 °C

(±1.8 °F at 77 °F).

Alarm

Setpoints

The user can set Alert and Danger setpoints for the value measured by the monitor using software configuration. Alarms are adjustable from 0 to 100% of full-scale for each measured value. The exception is when the full-scale range exceeds the range of the sensor. In this case, the range of the sensor will limit the setpoint. Accuracy of alarms are to within 0.13% of the desired value. The Temperature Monitors have both under and over alarm setpoints.

Alarm Time Delays

The user can program alarm delays using software as follows:

Alert From 1 to 60 seconds in 1 second intervals.

Danger From 1 to 60 seconds in 0.5 second intervals

Environmental Limits

Operating

Temperature

-30°C to +65°C (-22°F to +150 °F) when used with

Internal/External Termination

I/O Modules

0°C to +65 °C (32 °F to +150 °F)

when used with Internal Barrier

I/O Modules (Internal

Termination)

Storage

Temperature

-40°C to +85°C (-40°F to +185°F)

Physical

Monitor Module

Dimensions

(Height x Width x

Depth)

241.3 mm x 24.4 mm x

241.8 mm

(9.50 in x 0.96 in x 9.52 in)

Weight 0.91 kg (2.0 lb)

I/O Modules

Dimensions

(Height x Width x

Depth)

241.3 mm x 24.4 mm x 99.1

mm

(9.50 in x 0.96 in x 3.90 in)
Weight 0.45 kg (1.0 lb)
I/O Modules (internal barrier)
Dimensions
(Height x Width x
Depth)
241.3 mm x 24.4 mm x 163.1
mm
(9.50 in x 0.96 in x 6.42 in)
Weight 0.46 kg (1.01 lb)
Rack Space Requirements
Monitor
Module
1 full-height front slot
I/O Modules 1 full-height rear slot

